

# GigaMOS<sup>™</sup> Trench HiperFET<sup>™</sup> Power MOSFET

## IXFN420N10T

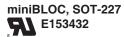


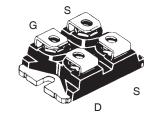
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode

Symbol	bol Test Conditions		Maximum Ratings		
V <sub>DSS</sub>	T <sub>J</sub> = 25°C to 175°	С	100	V	
V <sub>DGR</sub>	$T_J = 25^{\circ}C \text{ to } 175^{\circ}$	$C$ , $R_{GS} = 1M\Omega$	100	V	
V <sub>GSS</sub>	Continuous		±20	V	
V <sub>GSM</sub>	Transient		±30	V	
I <sub>D25</sub>	T <sub>C</sub> = 25°C (Chip C	Capability)	420	A	
I <sub>L(RMS)</sub>	External Lead Cur	rent Limit	200	Α	
I <sub>DM</sub>	$T_{\rm C} = 25^{\circ}$ C, Pulse	Width Limited by $T_{_{JM}}$	1000	Α	
I <sub>A</sub>	T <sub>C</sub> = 25°C		100	A	
E <sub>AS</sub>	$T_{\rm C} = 25^{\circ}{\rm C}$		5	J	
dV/dt	$I_{S} \leq I_{DM}, V_{DD} \leq V_{DS}$	<sub>SS</sub> , T <sub>J</sub> ≤ 175°C	20	V/ns	
$\mathbf{P}_{D}$	T <sub>C</sub> = 25°C		1070	W	
T <sub>J</sub>			-55 +175	°C	
T <sub>JM</sub>			175	°C	
T <sub>stg</sub>			-55 +175	°C	
V <sub>ISOL</sub>	50/60 Hz, RMS	t = 1 minute	2500	V~	
	$I_{ISOL} \le 1 mA$	t = 1 second	3000	V~	
M <sub>d</sub>	Mounting Torque		1.5/13	Nm/lb.in	
-	Terminal Connecti	Terminal Connection Torque		Nm/lb.in	
Weight			30	g	

Symbol Test Conditions $(T_J = 25^{\circ}C, Unless Otherwise Specified)$		Chara Min.	Characteristic Values Min.   Typ.   Max.			
BV <sub>DSS</sub>	$V_{GS} = 0V, I_{D} = 3mA$	100			V	
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 8mA$	2.5		5.0	V	
I <sub>GSS</sub>	$V_{GS} = \pm 20V, V_{DS} = 0V$			±200	nA	
I <sub>DSS</sub>	$V_{DS} = V_{DSS}, V_{GS} = 0V$ $T_{J} = 18$	50°C			μA mA	
R <sub>DS(on)</sub>	$V_{GS} = 10V, I_{D} = 60A, \text{ Note 1}$			2.3	mΩ	

 $V_{DSS} = 100V$   $I_{D25} = 420A$   $R_{DS(on)} \le 2.3m\Omega$   $t_{rr} \le 140ns$ 





G = Gate D = Drain S = Source

Either Source Terminal S can be used as the Source Terminal or the Kelvin Source ( Gate Return ) Terminal.

#### **Features**

- International Standard Package
- miniBLOC, with Aluminium Nitride Isolation
- Isolation Voltage 2500 V~
- High Current Handling Capability
- Fast Intrinsic Diode
- Avalanche Rated
- Low R<sub>DS(on)</sub>

### **Advantages**

- Easy to Mount
- Space Savings
- High Power Density

### **Applications**

- Synchronous Recification
- DC-DC Converters
- Battery Chargers
- Switch-Mode and Resonant-Mode Power Supplies
- DC Choppers
- AC Motor Drives
- Uninterruptible Power Supplies
- High Speed Power Switching Applications



Symbol (T = 25°C,	Test Conditions Unless Otherwise Specified)	Char Min.	acteristic Typ.	Values Max.
g <sub>fs</sub>	$V_{DS} = 10V, I_{D} = 60A, \text{ Note 1}$	110	185	S
C <sub>iss</sub>			47	nF
C <sub>oss</sub>	$V_{GS} = 0V, V_{DS} = 25V, f = 1MHz$		4390	pF
C <sub>rss</sub>			530	pF
$R_{Gi}$	Gate Input Resistance		1.46	Ω
t <sub>d(on)</sub>	$\begin{cases} & \textbf{Resistive Switching Times} \\ & \textbf{V}_{GS} = 10 \textbf{V}, \ \textbf{V}_{DS} = 0.5 \bullet \textbf{V}_{DSS}, \ \textbf{I}_{D} = 100 \textbf{A} \\ & \textbf{R}_{G} = 1 \Omega \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$		47	ns
t <sub>r</sub>			155	ns
t <sub>d(off)</sub>			115	ns
<u>t,</u>			255	ns
Q <sub>g(on)</sub>			670	nC
Q <sub>gs</sub>	$ V_{GS} = 10V, V_{DS} = 0.5 \cdot V_{DSS}, I_{D} = 0.5 \cdot I_{D25} $		170	nC
$Q_{gd}$			195	nC
R <sub>thJC</sub>				0.14 °C/W
R <sub>thCS</sub>			0.05	°C/W

### SOT-227B (IXFN) Outline (M4 screws (4x) supplied) MILLIMETERS MYZ MAX 1.255 .323 MIN 31.50 7.80 4.09 4.09 MAX 31.88 8.20 4.29 .161 .161 .169 .169 4.29 .161 30.12 38.00 11.68 .481 .378 .033 .506 1.001 .460 12.22 9.60 0.84 25.42 2.13 5.97 26.90 4.42 4.85 25.07 .084 .195 1.045 -.002 .004 -0.05 0.1

#### Source-Drain Diode

SymbolTest ConditionsChar $(T_J = 25^{\circ}C, Unless Otherwise Specified)$ Min.		acteristic Values  Typ.   Max.		
$V_{GS} = 0V$			420	Α
Repetitive, Pulse Width	Limited by T <sub>JM</sub>		1680	Α
$V_{SD}$ $I_F = 60A, V_{GS} = 0V, Not$	e 1		1.2	V
$ \begin{vmatrix} \mathbf{t}_{rr} \\ \mathbf{Q}_{RM} \\ \mathbf{I}_{RM} \end{vmatrix}  \begin{cases} \mathbf{I}_{F} = 150 \text{A}, \ \mathbf{V}_{GS} = 0 \text{V} \\ -\text{di/dt} = 100 \text{A/} \mu \text{s} \\ \mathbf{V}_{R} = 60 \text{V} \end{cases} $		0.38 7.00	140	ns µC A

Note 1. Pulse test,  $t \le 300\mu s$ ; duty cycle,  $d \le 2\%$ .

# **IXFN420N10T**



Fig. 1. Output Characteristics

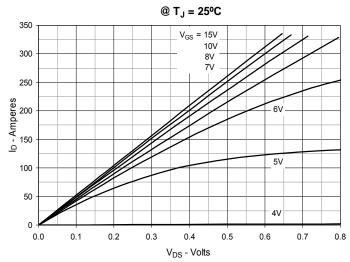


Fig. 2. Extended Output Characteristics

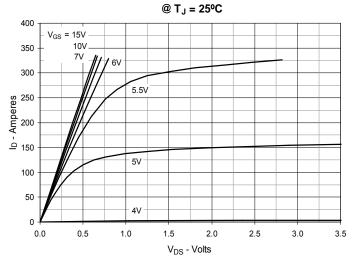


Fig. 3. Output Characteristics

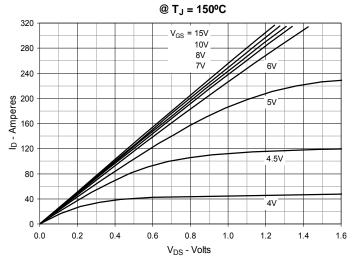


Fig. 4. Normalized R<sub>DS(on)</sub> vs. Junction Temperature

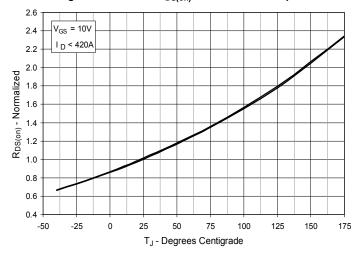


Fig. 5. Normalized R<sub>DS(on)</sub> vs. Drain Current

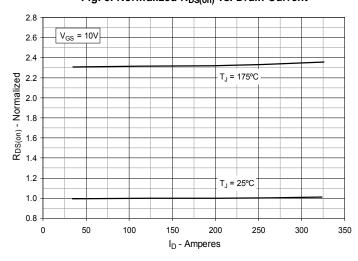
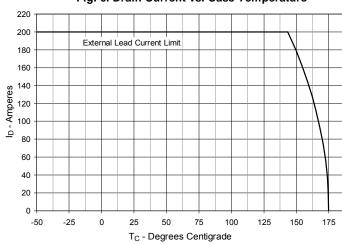
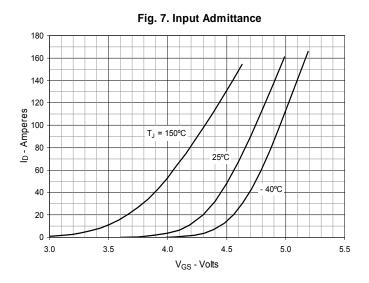
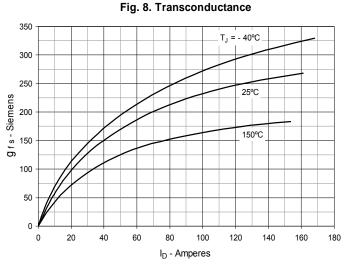


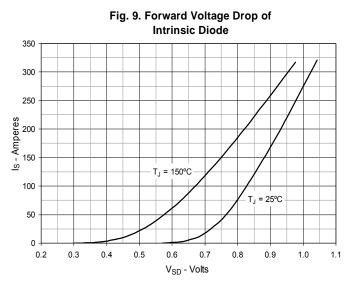
Fig. 6. Drain Current vs. Case Temperature

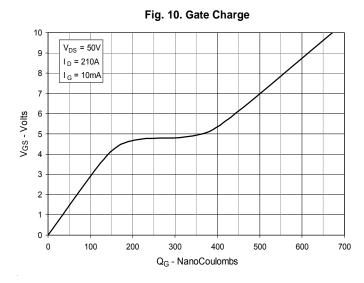


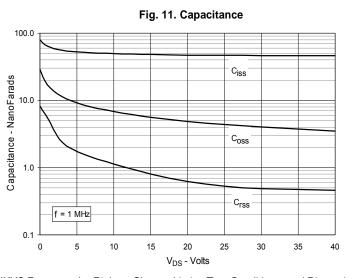


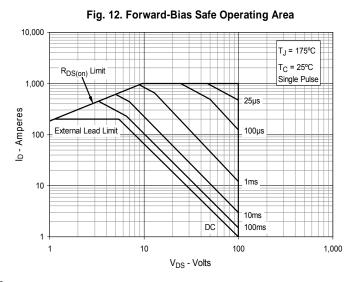












IXYS Reserves the Right to Change Limits, Test Conditions, and Dimensions.



Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

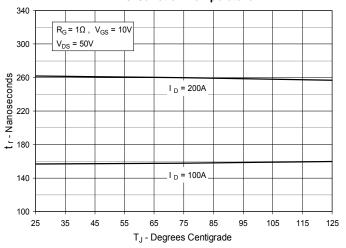


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

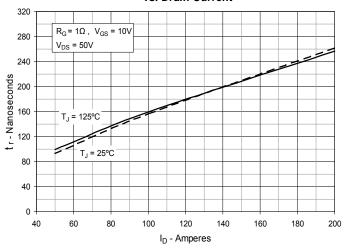


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

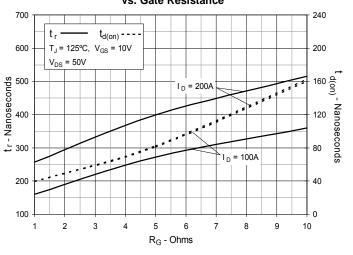


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

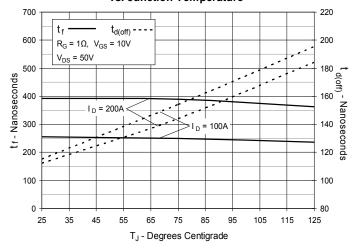


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

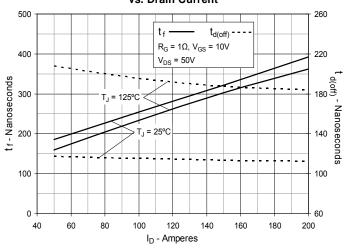
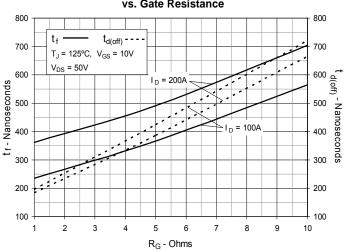


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance



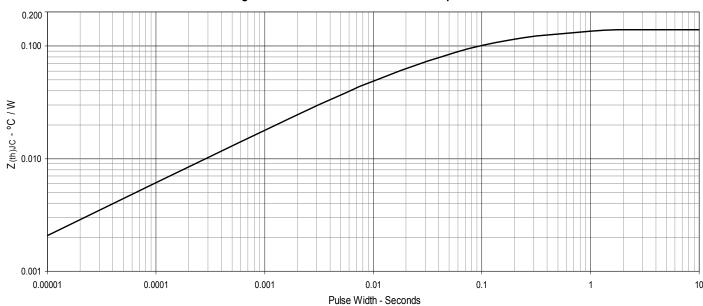


Fig. 19. Maximium Transient Thermal Impedance

